The background features a series of stylized, overlapping arrows pointing towards the center. On the left, there are five orange-to-red gradient arrows pointing right. On the right, there are five blue-to-white gradient arrows pointing left. In the center, the 'NH' logo is repeated in a larger size, with the red chevron and trademark symbol.

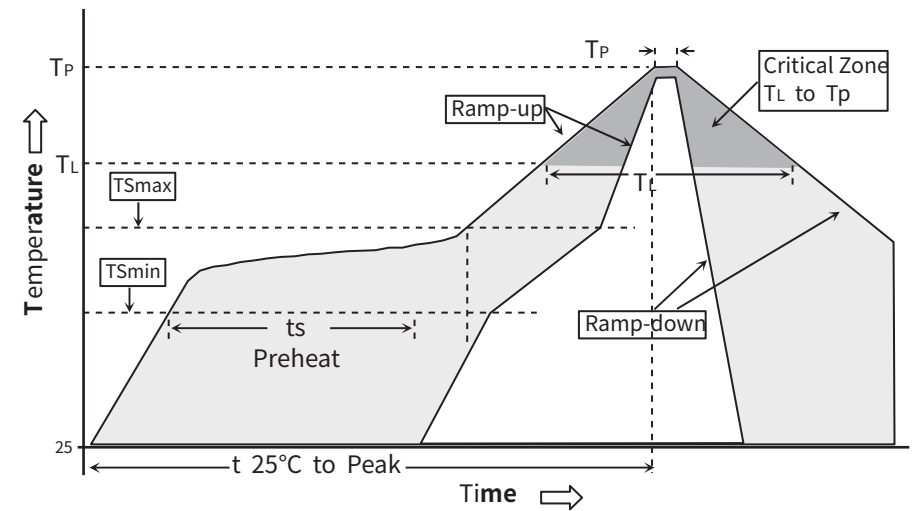
NH

焊接技术

welding technique

Recommended temperature profile for IR reflow

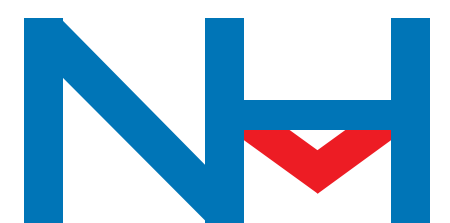
Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (T _{smax} to T _p)	3°C/second max.	3°C/second max.
Preheat -Temperature Min(TS min) -Temperature Max(TS max) -Time(ts min to ts max)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: -Temperature (TL) -Time (tL)	183°C 60-150 seconds	217°C 60-150 seconds
Peak Temperature(TP)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.



Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

Note : All temperatures refer to topside of the package, measured on the package body surface.



Thanks
感谢观看